



To the Honorable Commissioner of Patents and Trade.

102381977

Documents or copy thereof.

1. Name of conveying party(ies):

Akimasa SOYANO; Hiroyuki ISHII; Hidemitsu ISHIDA;
Motoyuki SHIMA and Yukio NISHIMURAAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

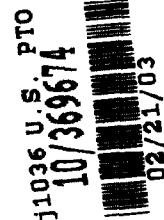
3. Nature of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: February 12, 2003

2. Name and address of receiving party(ies):

Name: JSR Corporation

Address: 2-11-24, Tsukiji, Chuo-ku
Tokyo, JAPANAdditional name(s) and address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: February 12, 2003

A. Patent Application No.(s)

B. Patent No.(s)

10369674

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Supervisor, Patent Prosecution Services
PIPER RUDNICK LLP
1200 Nineteenth Street, N.W.
Washington, D.C. 20036-2412
Telephone No. (202) 861-3900
Facsimile No. (202) 223-2085

6. Total applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number: 50-1442

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9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Christopher W. Raimund

Name of Person Signing

Signature

February 21, 2003

Date

Registration Number: 47,258

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02/25/2003 AADDFD1 00000027 10369674

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Assignment of Application

WHEREAS, I (WE) Akimasa SOYANO, Hiroyuki ISHII, Hidemitsu ISHIDA,
Motoyuki SHIMA, and Yukio NISHIMURA each having an address of 5-6-3-1B, Hinaga,
Yokkaichi, Mie 510-0891, Japan, 2-3-15-203, Higashihino, Yokkaichi, Mie 510-0941,
Japan, 5-64-13, Sasagawa, Yokkaichi, Mie 510-0944, Japan, 1-14-106, Morigayama-cho,
Yokkaichi, Mie 510-0957, Japan, and 1-12-102, Morigayama-cho, Yokkaichi, Mie 510-0957,
Japan

, respectively,

have invented certain new and useful improvements in: RADIATION-SENSITIVE

RESIN COMPOSITION

for which an application for Letters Patent was executed on February 12, 2003

(Application No. _____, Filed _____), and

WHEREAS, JSR Corporation

(hereinafter referred to as "ASSIGNEE") having a place of business at:

2-11-24, Tsukiji, Chuo-ku, Tokyo, Japan

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Piper Marbury Rudnick & Wolfe LLP, Attorneys at Law, 1200 Nineteenth Street, N.W., Washington, D.C. 20036, the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: February 12, 2003

Akimasa SOYANO
(Signature of Inventor) Akimasa SOYANO

Date: February 12, 2003

Hirofumi Kato
(Signature of Inventor) Hirofumi KATO

Date: February 12, 2003

Hidemitsu ISHIDA
(Signature of Inventor) Hidemitsu ISHIDA

Date: February 12, 2003

Motoyuki Shima
(Signature of Inventor) Motoyuki SHIMA

Date: February 12, 2003

Yukio Nishimura
(Signature of Inventor) Yukio NISHIMURA

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)

**PIPER MARBURY
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